PZT2907A

PNP Silicon Epitaxial Transistor

This PNP Silicon Epitaxial transistor is designed for use in linear and switching applications. The device is housed in the SOT-223 package which is designed for medium power surface mount applications.

Features

- NPN Complement is PZT2222AT1
- The SOT-223 Package can be Soldered Using Wave or Reflow
- SOT-223 Package Ensures Level Mounting, Resulting in Improved Thermal Conduction, and Allows Visual Inspection of Soldered Joints. The Formed Leads Absorb Thermal Stress during Soldering Eliminating the Possibility of Damage to the Die
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V _{CEO}	-60	Vdc
Collector - Base Voltage	V _{CBO}	-60	Vdc
Emitter – Base Voltage	V _{EBO}	-5.0	Vdc
Collector Current – Continuous	Ic	-600	mAdc

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

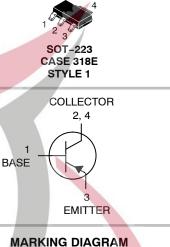
			100
Characteristic	Symbol	Max	Unit
Total Device Dissipation (Note 1) T _A = 25°C	PD	1.5 12	W mW/°C
Thermal Resistance Junction-to-Ambient (Note 1)	R _{θJA}	83.3	°C/W
Lead Temperature for Soldering, 0.0625″ from case Time in Solder Bath	ΤL	260 10	°C Sec
Operating and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C

1. FR-4 with 1 oz and 713 mm^2 of copper area.



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P2F = Specific Device Code A = Assembly Location Y = Year W = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION						
Device	Package	Shipping [†]				
PZT2907AT1G	SOT-223 (Pb-Free)	1,000 / Tape & Reel				
SPZT2907AT1G	SOT-223 (Pb-Free)	1,000 / Tape & Reel				
PZT2907AT3G	SOT–223 (Pb–Free)	4,000 / Tape & Reel				

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

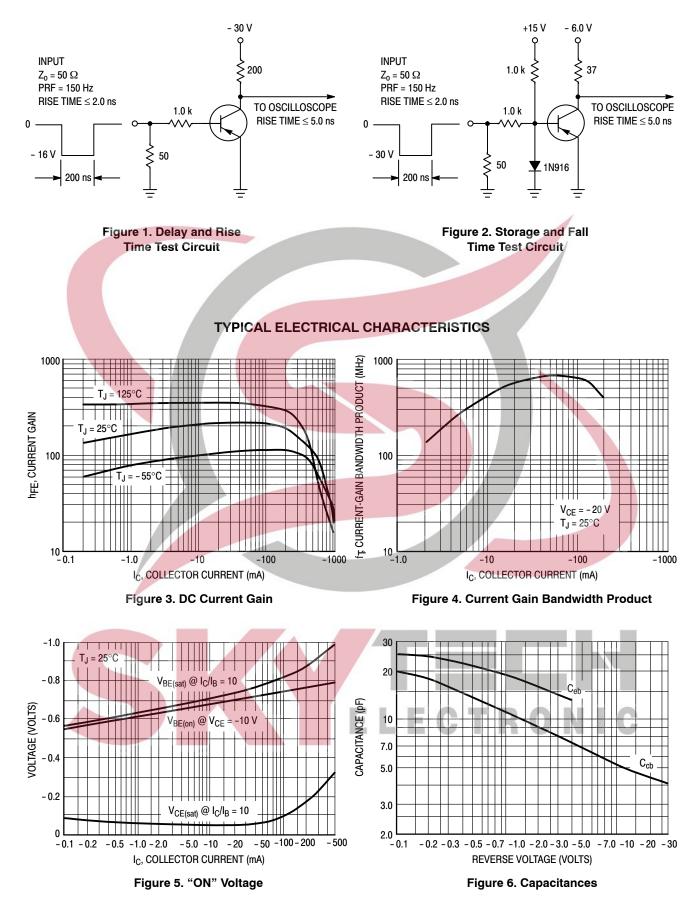
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ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Тур	Мах	Unit
OFF CHARACTERISTICS		•				•
Collector-Base Breakdown Volta $(I_C = -10 \ \mu Adc, I_E = 0)$	age	V _{(BR)CBO}	-60	_	-	Vdc
Collector–Emitter Breakdown Vo $(I_{C} = 10 \text{ mAdc}, I_{B} = 0)$	ltage	V _{(BR)CEO}	- 60	_	_	Vdc
Emitter–Base Breakdown Voltag ($I_E = -10 \ \mu Adc, I_C = 0$)	e	V _{(BR)EBO}	-5.0	-	-	Vdc
$\begin{array}{l} Collector-Base \ Cutoff \ Current \\ (V_{CB}=-50 \ Vdc, \ I_{E}=0) \end{array}$		I _{CBO}	-	_	-10	nAdc
$\begin{array}{l} \mbox{Collector-Emitter Cutoff Current} \\ \mbox{(V}_{CE} = -30 \mbox{ Vdc}, \mbox{ V}_{BE} = 0.5 \mbox{ Vd} \end{array}$		I _{CEX}	-	-	-50	nAdc
Base-Emitter Cutoff Current (V _{CE} = -30 Vdc, V _{BE} = -0.5 V	/dc)	I _{BEX}		-	-50	nAdc
ON CHARACTERISTICS (No	ote 2)					•
$\begin{array}{l} \text{DC Current Gain} \\ (I_{C} = -0.1 \text{ mAdc}, V_{CE} = -10 \text{ V} \\ (I_{C} = -1.0 \text{ mAdc}, V_{CE} = -10 \text{ V} \\ (I_{C} = -10 \text{ mAdc}, V_{CE} = -10 \text{ V} \\ (I_{C} = -150 \text{ mAdc}, V_{CE} = -10 \text{ V} \\ (I_{C} = -500 \text{ mAdc}, V_{CE} = -10 \text{ V} \\ \end{array}$	dc) ic) /dc)	h _{FE}	75 100 100 100 50		- - 300 -	_
$\begin{array}{l} \mbox{Collector-Emitter Saturation Volt} \\ (I_C = -150 \mbox{ mAdc}, I_B = -15 \mbox{ mAdc}, I_C = -500 \mbox{ mAdc}, I_B = -50 \mbox{ mAdc}, I$	dc)	V _{CE(sat)}	=	-	-0.4 -1.6	Vdc
Base-Emitter Saturation Voltage $(I_C = -150 \text{ mAdc}, I_B = -15 \text{ mA})$ $(I_C = -500 \text{ mAdc}, I_B = -50 \text{ mA})$	dc)	V _{BE(sat)}	-	-	-1.3 -2.6	Vdc
DYNAMIC CHARACTERIST	ICS					
Current-Gain – Bandwidth Produ $(I_C=-50\mmode{ mAdc},V_{CE}=-20\mmode{ V}$		f _T	200	_	_	MHz
Output Capacitance ($V_{CB} = -10 \text{ Vdc}, I_E = 0, f = 1.0$	MHz)	C _c	-	-	8.0	pF
Input Capacitance ($V_{EB} = -2.0 \text{ Vdc}, I_C = 0, f = 1.0 \text{ MHz}$)		C _e	-	_	30	pF
SWITCHING TIMES						
Turn-On Time		t _{on}	_	_	45	ns
Delay Time	$(V_{CC} = -30 \text{ Vdc}, I_C = -150 \text{ mAdc}, I_{B1} = -15 \text{ mAdc})$	t _d	_	_	10	
Rise Time		tr	_	-	40	
Turn-Off Time		t _{off}	-	_	100	ns
Storage Time Fall Time	$(V_{CC} = -6.0 \text{ Vdc}, I_C = -150 \text{ mAdc}, I_{B1} = I_{B2} = -15 \text{ mAdc})$	t _s t _f	CTI	101	80 30) /

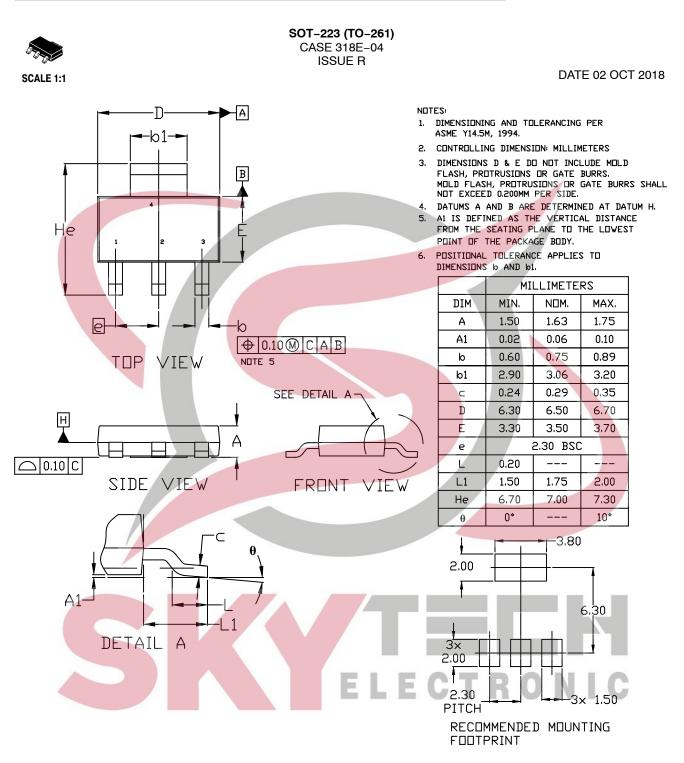
2. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

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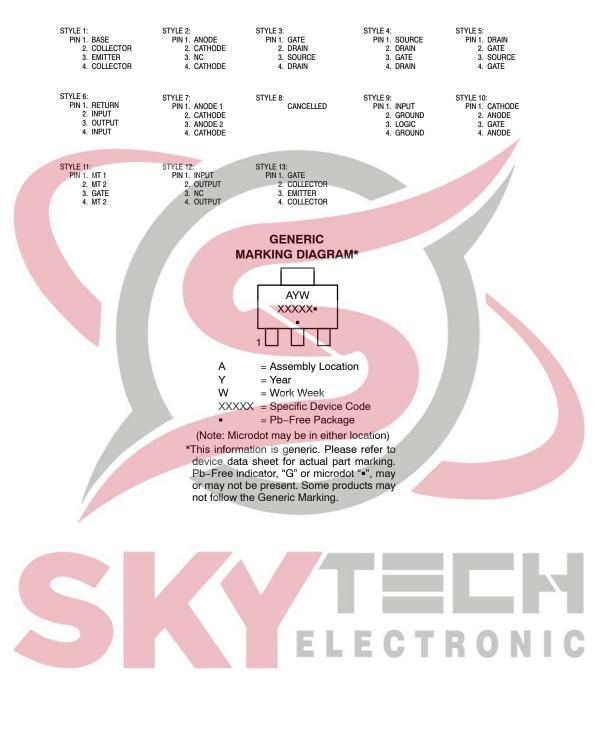


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